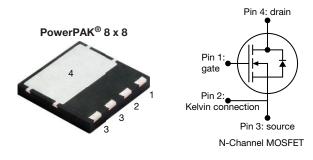
SiHH070N60EF

Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



www.vishay.com

PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	650					
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.061				
Q _g max. (nC)	75					
Q _{gs} (nC)	20					
Q _{gd} (nC)	17					
Configuration	Single					

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and halogen-free	SiHH070N60EF-T1GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	V	
Gate-source voltage			V _{GS}	± 30	v	
Continuous drain current (T _J = 150 °C)	V at 10 V	T _C = 25 °C	- I _D	36		
	V _{GS} at 10 V	T _C = 100 °C		23	А	
Pulsed drain current ^a			I _{DM}	93	1	
Linear derating factor				1.6	W/°C	
Single pulse avalanche energy ^b			E _{AS}	226	mJ	
Maximum power dissipation			PD	202	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = '	T _J = 125 °C		100	V/ns	
Reverse diode dv/dt ^d			dv/dt	50	v/ns	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4 A
- c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 900 A/µs, starting T_J = 25 °C

1 For technical questions, contact: <u>hvm@vishay.com</u>



COMPLIANT

HALOGEN

FREE



PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	38		50 0.62					
Maximum junction-to-case (drain)	R _{thJC}	0.48				°C/W			
	1	4	I						
SPECIFICATIONS (T _J = 25 °C, u	unless otherwi	ise noted)							
PARAMETER	SYMBOL	TES	T CONDITIC	ONS	MIN.	TYP.	MAX.	UNIT	
Static					•	•			
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 25	i0 μA	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D) = 20 mA	-	0.51	-	V/°C	
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 25	50 µA	3	-	5	V	
Onto norma lankana		$V_{GS} = \pm 20 V$		-	-	± 100	nA		
Gate-source leakage	I _{GSS}	\ \	$V_{\rm GS} = \pm 30$ V	,	-	-	± 1	μA	
		$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	μA		
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	, V _{GS} = 0 V,	T _J = 125 °C	-	-	2	mA	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D :	= 15 A	-	0.061	0.071	Ω	
Forward transconductance ^a	9 _{fs}	V _{DS} :	= 20 V, I _D = ⁻	15 A	-	10.5	-	S	
Dynamic					•	•			
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2647	-			
Output capacitance	C _{oss}			-	122	-	pF		
Reverse transfer capacitance	C _{rss}			-	6	-			
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	90	-			
Effective output capacitance, time related ^b	C _{o(tr)}			-	560	-			
Total gate charge	Qg				-	50	75		
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	V _{GS} = 10 V I _D = 15 A, V _{DS} = 480 V		-	20	-	nC	
Gate-drain charge	Q _{gd}				-	17	-		
Turn-on delay time	t _{d(on)}				-	36	72		
Rise time	t _r	V _{DD} =	V _{DD} = 480 V, I _D = 15 A,		-	79	119		
Turn-off delay time	t _{d(off)}	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	55	83	ns		
Fall time	t _f			-	38	76			
Gate input resistance	R _g	f = 1 MHz		0.3	0.7	1.4	Ω		
Drain-Source Body Diode Characteristi	cs								
Continuous source-drain diode current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	36			
Pulsed diode forward current	I _{SM}			-	-	93	A		

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

V_{SD}

 t_{rr}

Q_{rr}

I_{RRM}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

Diode forward voltage

Reverse recovery time

Reverse recovery charge

Reverse recovery current

2

 $T_J = 25 \ ^{\circ}C, \ I_S = 15 \ A, \ V_{GS} = 0 \ V$

 $\begin{array}{l} T_J=25~^\circ C,~I_F=I_S=15~A,\\ di/dt=100~A/\mu s,~V_R=400~V \end{array}$

٧

ns

μC A

1.2

272

1.8

_

_

136

0.9

12

-

-

-

-



SiHH070N60EF

Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

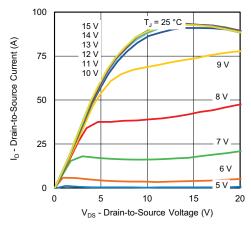


Fig. 1 - Typical Output Characteristics

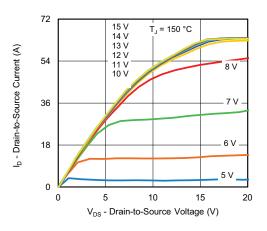


Fig. 2 - Typical Output Characteristics

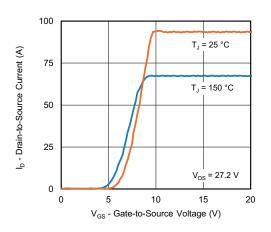


Fig. 3 - Typical Transfer Characteristics

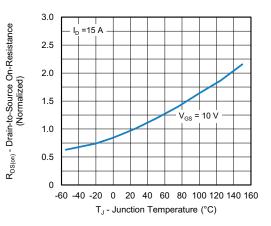


Fig. 4 - Normalized On-Resistance vs. Temperature

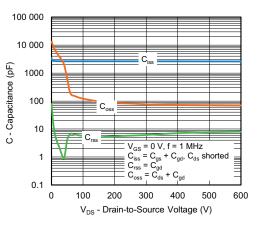


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

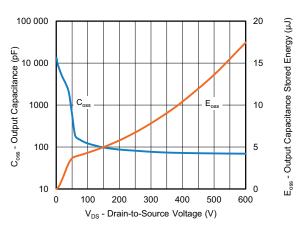


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

S20-0109-Rev. B, 02-Mar-2020

3 questions contact: hym@vis Document Number: 92290

For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>wvwv.vishay.com/doc?91000</u>



SiHH070N60EF

Vishay Siliconix

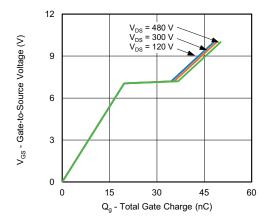


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

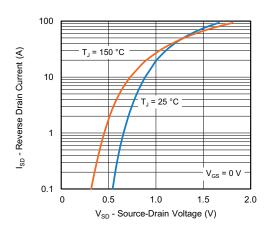


Fig. 8 - Typical Source-Drain Diode Forward Voltage

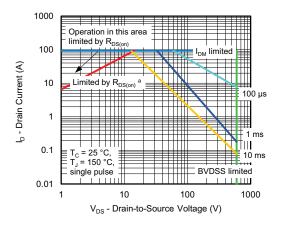


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

4

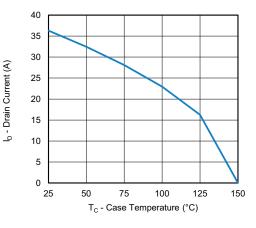


Fig. 10 - Maximum Drain Current vs. Case Temperature

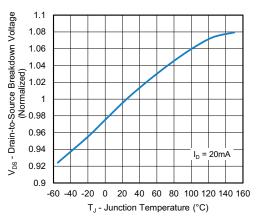


Fig. 11 - Temperature vs. Drain-to-Source Voltage

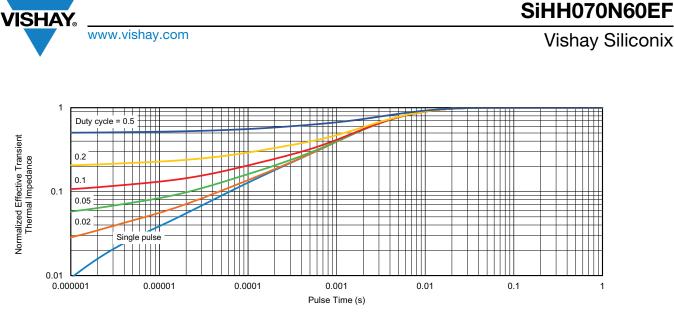


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

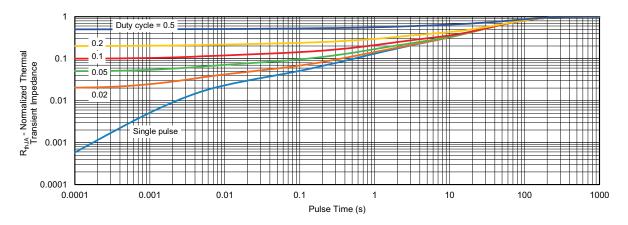


Fig. 13 - Normalized Transient Thermal Impedance, Junction-to-Ambient

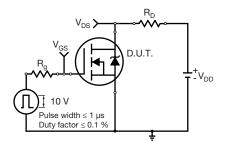


Fig. 14 - Switching Time Test Circuit

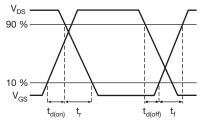


Fig. 15 - Switching Time Waveforms

S20-0109-Rev. B, 02-Mar-2020

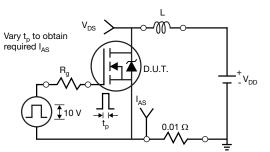
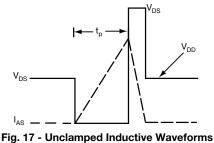


Fig. 16 - Unclamped Inductive Test Circuit



5

Document Number: 92290

For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>





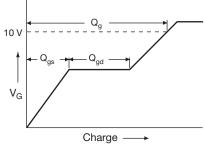


Fig. 18 - Basic Gate Charge Waveform

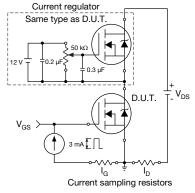


Fig. 19 - Gate Charge Test Circuit



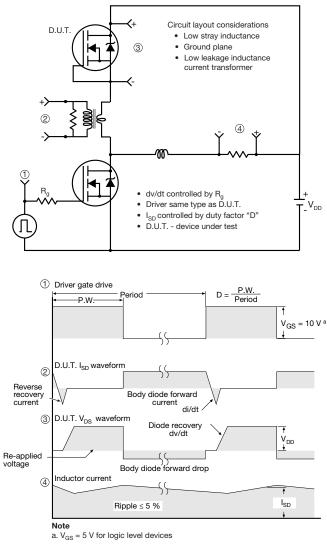
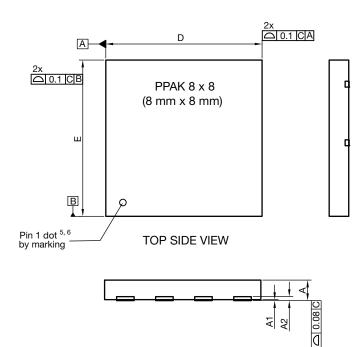


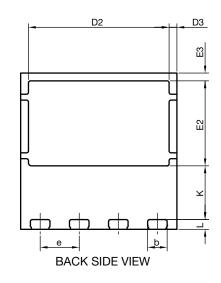
Fig. 20 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?92290.



PowerPAK[®] 8 x 8 Case Outline





DIM		MILLIMETERS			INCHES		
DIM. MIN.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.95	1.00	1.05	0.037	0.039	0.041	
A1	0.00	-	0.05	0.000	-	0.002	
A2		020 ref.			0.008 ref.		
b	0.95	1.00	1.05	0.037	0.039	0.041	
D	7.90	8.00	8.10	0.311	0.315	0.319	
D2	7.10	7.20	7.30	0.280	0.283	0.287	
D3		0.40 BSC		0.016 BSC			
е		2.00 BSC		0.079 BSC			
E	7.90	8.00	8.10	0.311	0.315	0.319	
E2	4.30	4.35	4.40	0.169	0.171	0.173	
E3		0.40 BSC			0.016 BSC		
К		2.75 BSC		0.108 BSC			
L	0.45	0.50	0.55	0.018	0.020	0.022	
N ⁽³⁾	8			8			

Notes

⁽¹⁾ Use millimeters as the primary measurement

⁽²⁾ Dimensioning and tolerances conform to ASME Y14.5 M - 1994

⁽³⁾ N is the number of terminals

⁽⁴⁾ The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

⁽⁵⁾ Exact shape and size of this feature is optional

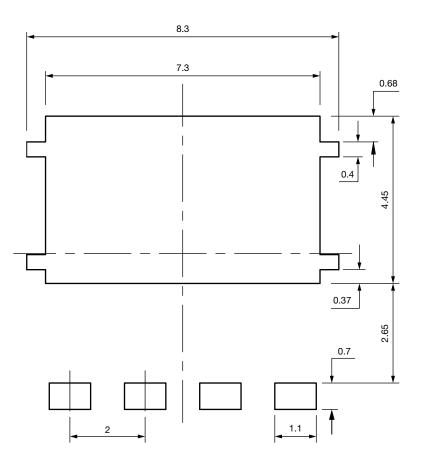
ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

1



Recommended Minimum PADs for PowerPAK[®] 8 mm x 8 mm



Dimensions in millimeters

Document Number: 68441



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.